1- Line, Bi-directional, Ultra-low Capacitance Transient Voltage Suppressor





DFN1006-2L

Features

- Stand-off voltage: 5V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): ±25kV (contact)
IEC61000-4-5(surge): 5A (8/20μs)
- Low leakage current:
- Ultra low clamping voltage
- RoHS Compliant

Applications

- Cellular Handsets and Accessories
- Display Ports
- MDDI Ports
- USB Ports
- Digital Visual Interface (DVI)
- PCI Express and Serial SATA Ports

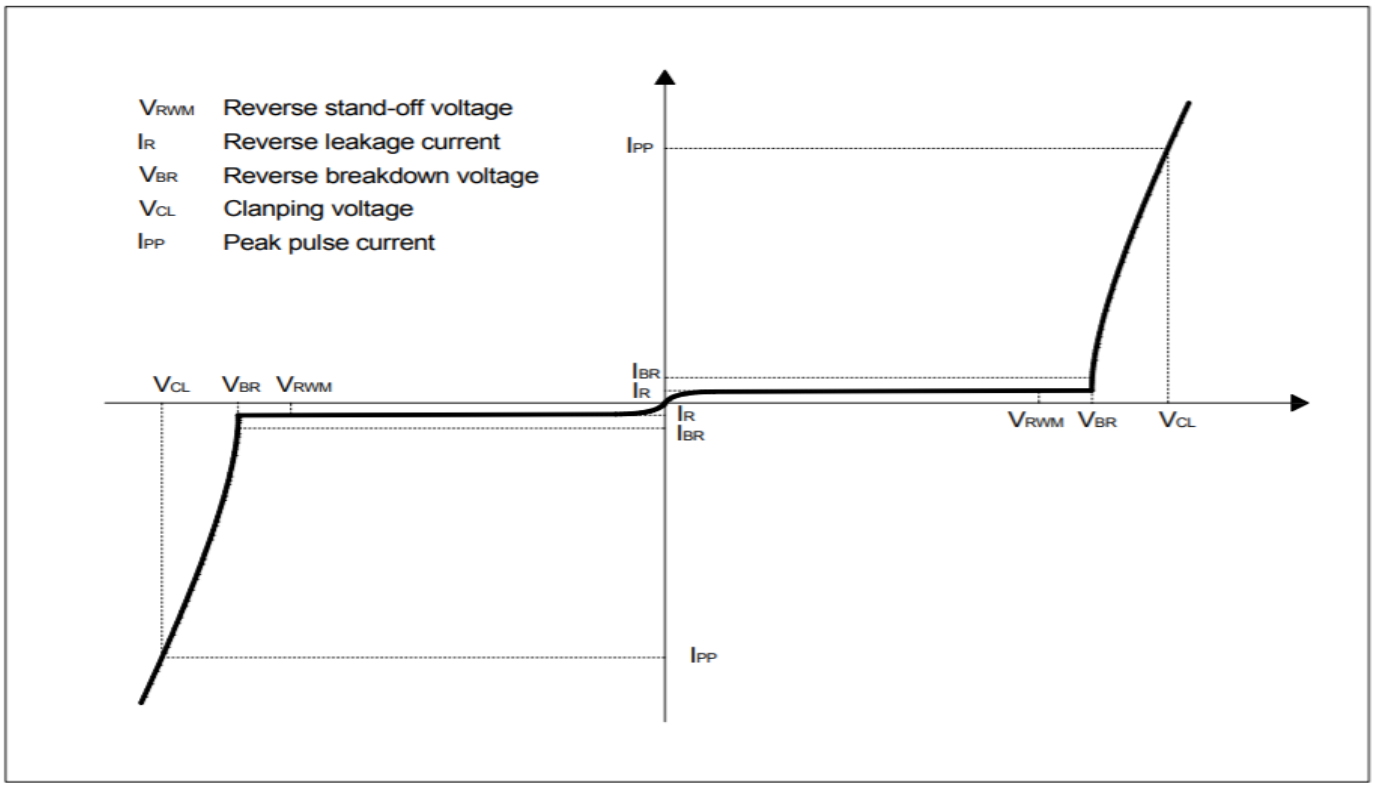
Mechanical Data

- **Package**: DFN1006-2L
- **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end
- **Marking:**

2V

2V = Device Marking Code

■Definitions of electrical characteristics



■Maximum Ratings

PARAMETER	SYMBOL	Rating	UNIT
Peak pulse power (t_p = 8/20μs)	P_{pk}	80	W
Peak pulse current (t_p = 8/20μs)	I_{PP}	5	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±25	KV
ESD according to IEC61000-4-2 contact discharge		±25	KV
Operating temperature	T_J	-55~125	°C
Storage temperature	T_{STG}	-55~150	°C

■Electrical Characteristics（T_a=25℃ Unless otherwise specified）

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				5
Reverse breakdown voltage	V_{BR}	V	I_{BR} = 1mA	6		
Reverse leakage current	I_R	uA	V_{RWM} =5V			0.2
Clamping voltage [3]	V_{CL}	V	I_{PP} = 1A, t_p = 8/20μs		9	10
		V	I_{PP} = 5A, t_p = 8/20μs		13	16
Junction capacitance	C_J	pF	V_R = 0V, f = 1MHz		0.3	

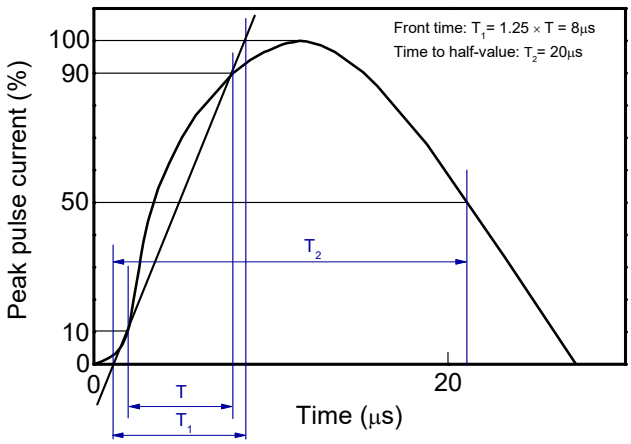
(1). TLP parameter: Z_0 = 50Ω, t_p = 100ns, t_r = 2ns, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.
(2). Contact discharge mode, according to IEC61000-4-2.
(3). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

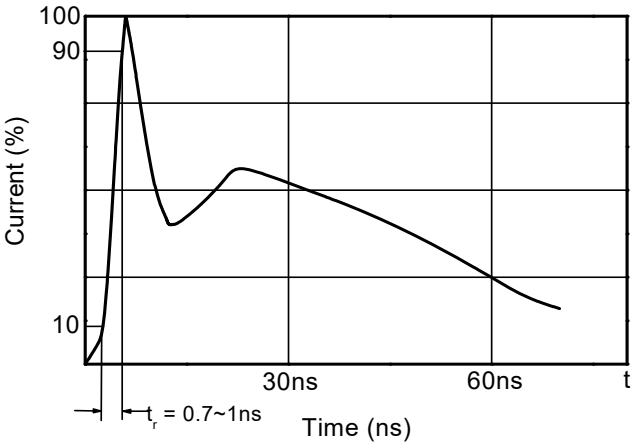
PREFERED P/N	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESDSLC5V0LBA1	Approximate 0.9	10000	100000	400000	7 Tape & reel

■ Characteristics (Typical)

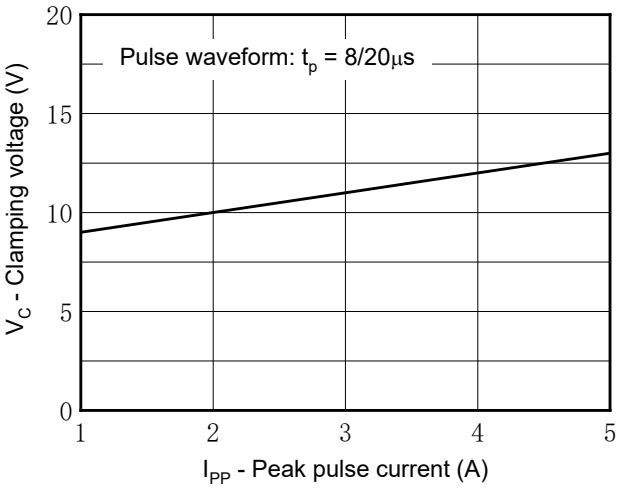
8/20μs waveform per IEC61000-4-5



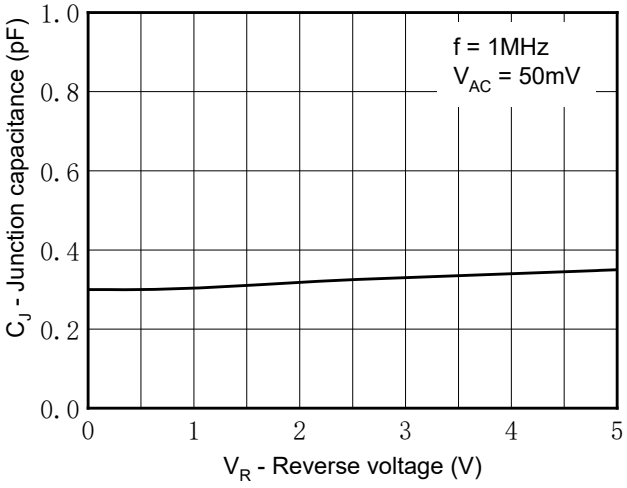
Contact discharge current waveform per IEC61000-4-2



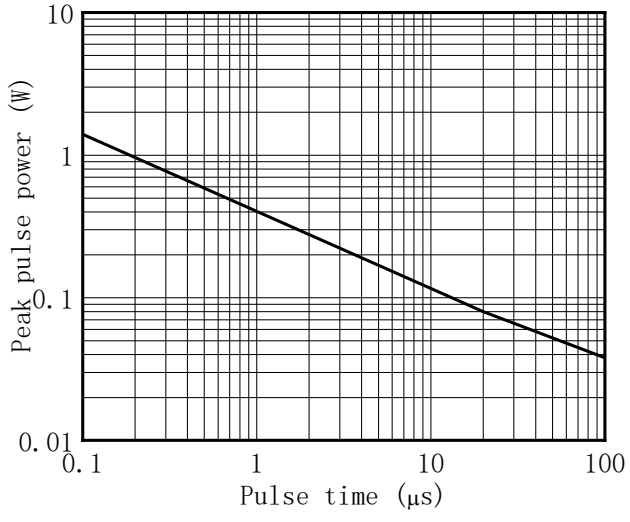
Clamping voltage vs. Peak pulse current



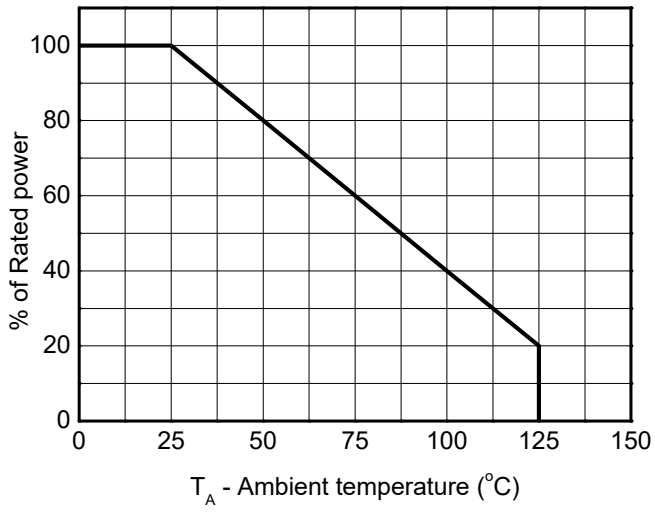
Capacitance vs. Reverse voltage



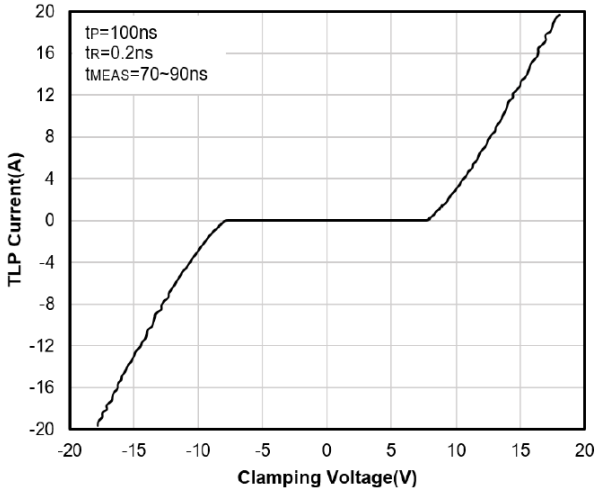
Non-repetitive peak pulse power vs. Pulse time



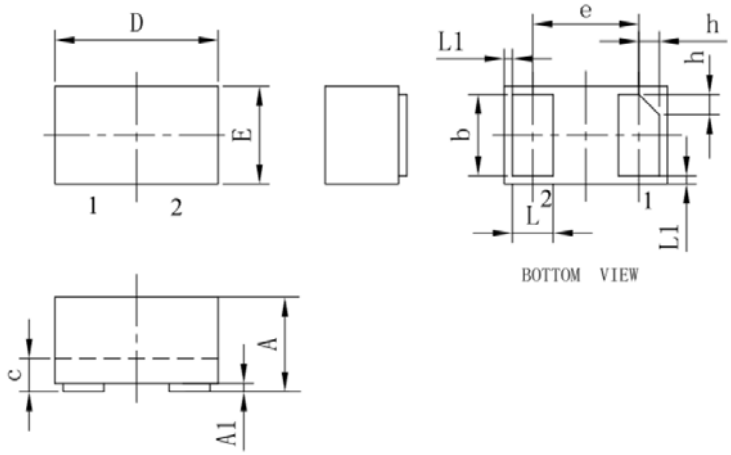
Power derating vs. Ambient temperature



TLP Measurement

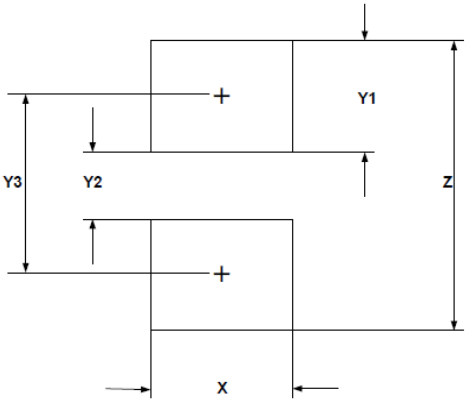


■ Outline Dimensions



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.45	0.50	0.55	0.018	0.020	0.022
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.45	0.50	0.55	0.018	0.020	0.022
c	0.12	0.15	0.18	0.005	0.006	0.007
D	0.95	1.00	1.05	0.037	0.039	0.041
e	0.65 BSC			0.026 BSC		
E	0.55	0.60	0.65	0.022	0.024	0.026
L	0.20	0.25	0.30	0.008	0.010	0.012
L1	0.05REF			0.002REF		
h	0.07	0.12	0.17	0.003	0.005	0.007

■ Recommend land pattern (Unit:mm)



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
X	0.60	0.024
Y1	0.50	0.020
Y2	0.30	0.012
Y3	0.80	0.032
Z	1.30	0.052

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met

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